



50V PNP SMALL SIGNAL TRANSISTOR IN X2-DFN1006-3

Features

- BV_{CEO} > -50V
- I_C = -100mA High Collector Current
- P_D = 1000mW Power Dissipation
- 0.60mm² Package Footprint, 13 Times Smaller than SOT23
- 0.4mm Height Package Minimizing Off-Board Profile
- Complementary NPN Type: DN0150BLP4
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

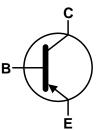
Mechanical Data

- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu.
 Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0008 grams (Approximate)

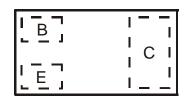
X2-DFN1006-3







Device Symbol



Top View Pin Configuration

Ordering Information (Note 4)

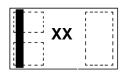
Part Number	Status	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DP0150ALP4-7	Obsolete	T5	7	8	3,000
DP0150ALP4-7B	Obsolete	T5	7	8	10,000
DP0150BLP4-7	Active	T6	7	8	3,000
DP0150BLP4-7B	Active	T6	7	8	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information

X2-DFN1006-3



XX = Product Type Marking Code



Absolute Maximum Ratings (@ TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-50	V
Collector-Emitter Voltage	V _{CEO}	-50	V
Emitter-Base Voltage	V_{EBO}	-5	V
Collector Current - Continuous	Ic	-100	mA
Peak Pulse Collector Current	I _{CM}	-200	mA
Base Current	Ι _Β	-30	mA

Thermal Characteristics (@ TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Dower Discipation	(Note 5)	D	400	mW	
Power Dissipation	(Note 6)	P _D	1000		
Thermal Resistance, Junction to Ambient	(Note 5)	6	310	°C/W	
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{\theta JA}$	120	*C/VV	
Thermal Resistance, Junction to Lead (Note 7)		$R_{ heta JL}$	120	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

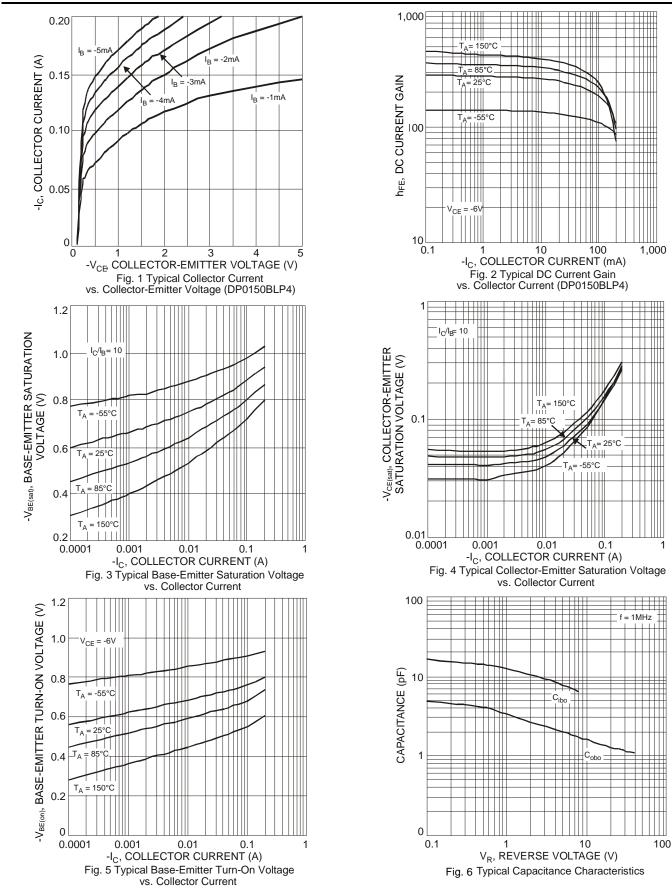
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						•
Collector-Base Breakdown Voltage	BV _{CBO}	-50	-100	_	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 8)	BV _{CEO}	-50	-79	_	V	$I_C = -1mA$
Emitter-Base Breakdown Voltage	BV _{EBO}	-6	-8.3	_	V	$I_E = -100 \mu A$
Collector Cut-Off Current	I _{CBO}	_	-1	-50	nA	$V_{CB} = -50V$
Collector Cut-Off Current	I _{CEX}	_	-1	-50	nA	$V_{CE} = -50V, V_{EB} = -3V$
Emitter Cut-Off Current	I _{EBO}	_	-1	-20	nA	$V_{EB} = -5V$
Base Cutoff Current	I _{BL}	_	-1	-50	nA	$V_{CE} = -50V, V_{EB} = -3V$
ON CHARACTERISTICS (Note 9)						
DC Current Gain DP0150BLP4	h _{FE}	200	300	400	_	$V_{CE} = -6V, I_{C} = -2mA$
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	-150	-300	mV	$I_C = -100 \text{mA}, I_B = -10 \text{mA}$
Base-Emitter Saturation Voltage	$V_{\text{BE(sat)}}$	-650 —	-740 -830	-850 -950	mV	$I_{C} = -10\text{mA}, I_{B} = -1\text{mA}$ $I_{C} = -50\text{mA}, I_{B} = -5\text{mA}$
SMALL SIGNAL CHARACTERISTICS						
Transition Frequency	f _T	80	_	_	MHz	$V_{CE} = -10V$, $I_{E} = -1mA$ f = 30MHz
Output Capacitance	C _{obo}	_	1.6	_	pF	$V_{CB} = -10V, I_{E} = 0,$ f = 1MHz

Notes:

- 5. For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady state condition. The entire exposed collector pad is attached to the heatsink.
- 6. Same as Note 5, except the exposed collector pad is mounted on 25mm x 25mm 2oz copper. 7. Thermal resistance from junction to solder-point (on the exposed collector pad).
- 8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.
- 9. Measured under pulsed conditions. Pulse width ≤ 300µs. Duty cycle ≤ 2%.

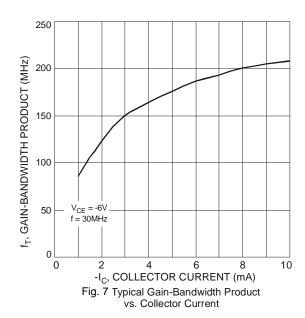


Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)





Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.) (continued)

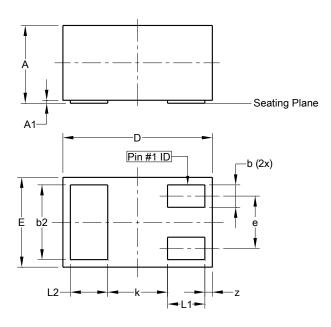




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3

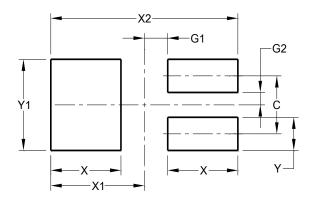


X2-DFN1006-3					
Dim	Min	Max	Тур		
Α		0.40			
A1	0.00	0.05	0.03		
b	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.05	1.00		
Е	0.55	0.65	0.60		
е			0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
k			0.40		
Z	0.02	0.08	0.05		
All Dimensions in mm					

Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$

X2-DFN1006-3



Dimensions	Value (in mm)
С	0.350
G1	0.150
G2	0.075
Χ	0.450
X1	0.600
X2	1.200
Υ	0.200
Y1	0.550



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